



Product Change Notification

Change Notification #: 118508-00
Change Title: Select Intel® SSD 670p Series
PCN 118508-00, Label
UPDATE RETAIL BOX ARTWORK FOR
UKCA CHANGE
Date of Publication: September 28, 2021

Key Characteristics of the Change:

Label, Label

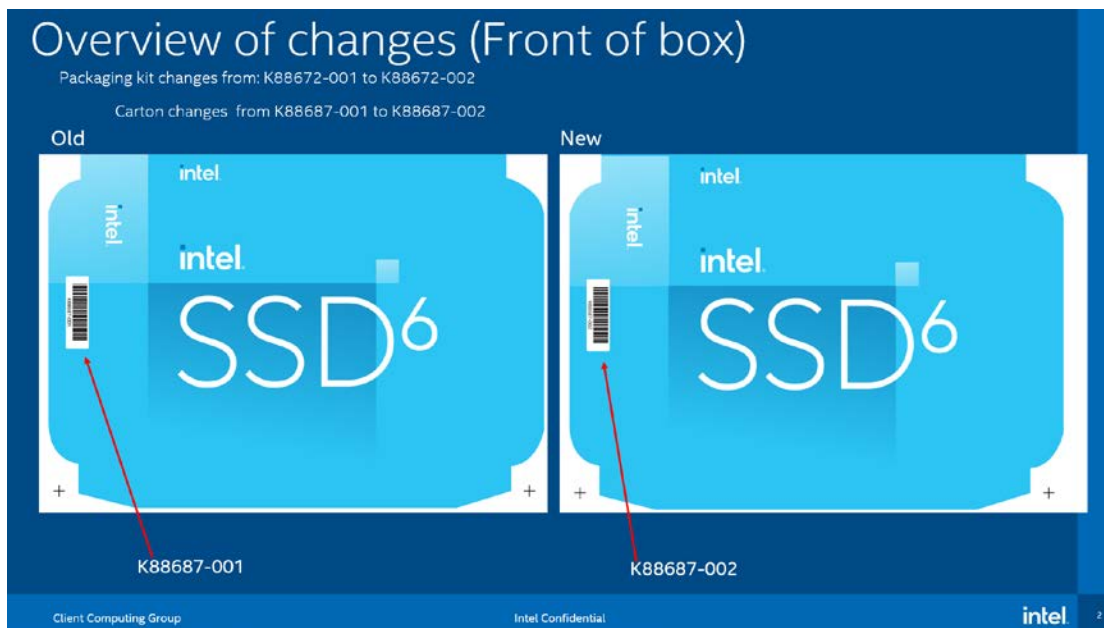
Forecasted Key Milestones:

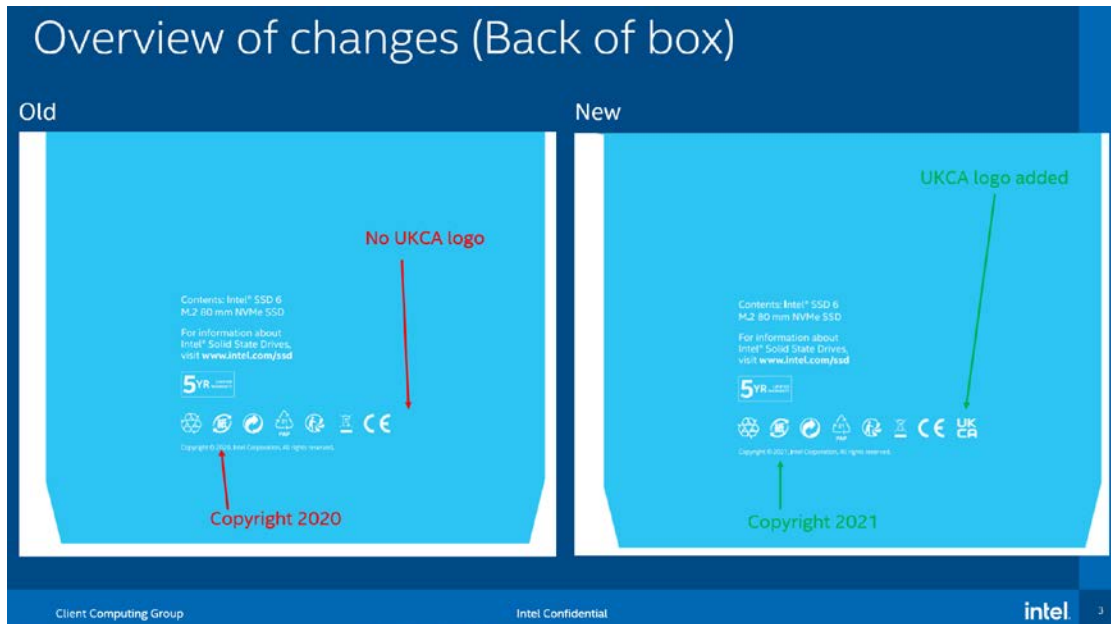
Date Customer Must be Ready to Receive Post-Conversion Material:	October 28, 2021
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Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes:

Packaging kit for MOQ 1 Retail Skus will have UKCA logo added.





Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product.

The change is only to the labels used in packaging.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD 670p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D4, QLC) Retail Box Single Pack	SSDPEKNU512GZX1	99A39N
Intel® SSD 670p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D4, QLC) Retail Box Single Pack	SSDPEKNU010TZX1	99A39P
Intel® SSD 670p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D4, QLC) Retail Box Single Pack	SSDPEKNU020TZX1	99A39R

PCN Revision History:

Date of Revision:
September 28, 2021

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Europe Email: eccb@intel.com

Japan Email: jcb.ijkk@intel.com

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